

## USB 2.0 eUSB

The Global Leader in Specialized Storage and Memory Solutions



## **KEY FEATURES**

- Superior Random Write Performance
- Global wear leveling
- Power Loss Protection
- Hardware Write Protect\*
- \* May vary by product and project support

The ATP eUSB module employs the widely supported USB interface, making it a suitable boot device and efficient data storage solution.

Ideal for industrial and rugged environments, the eUSB module is cost-effective and offers data transfer efficiency in a wide range of applications such as networking, embedded and medical applications that previously used the Intel® Z-U130 Value SSD.

With Power Loss Protection technology options featuring built-in hardware-based power backup circuit and/or firmware-based solution, ATP eUSB delivers reliable controller and lasting NAND flash operation even during sudden power-loss events.

Technologies		S.M.A.R.T/ Life Monitor	Industrial Temperature		Hardware-Based Power Loss Protection	Advanced Wear Leveling	Hardware Write Protect
Premium		0	0	0	<b>A</b>	0	<b>A</b>
Superior		0		0	0	0	

▲: Customization option available on a project basis.

## **Specifications**

Durahash Line	Pren	Superior						
Product Line	B800Pi	B800Pi	B600Sc					
Interface	USB 2.0 (480 Mbps)							
Flash Type	SL	MLC						
Form Factor	Pitch 2.54 mm / 2.00 mm							
Operating Temperature	-40°C to	0°C to 70°C						
Power Loss Protection Options	Firmware Based	mware Based						
Optional SED Features		-						
Capacity	1 GB to 16 GB	1 GB to 32 GB	8 GB to 32 GB					
Performance								
Sequential Read (MB/s) up to	37	30	25					
Sequential Write (MB/s) up to	23	25	19					
Endurance and Reliability								
Endurance (TBW)1 up to	1,548 TB	640 TB	19 TB <sup>2</sup>					
Reliability MTBF @ 25°C	>5,000,0	>2,000,000 hours						
Reliability Number of Insertions								
Others								
Dimensions (mm)	36.9 x 26.6 x 9.5							
Certifications								
Warranty	5 \	3 years						

- 1. Under highest Sequential write value. May vary by density, configuration and applications. 2. Measured with Random Write. May vary by density, configuration and applications.



Product spec and its related information are subject to change without advance notice.

Please refer to <a href="www.atpinc.com">www.atpinc.com</a> for latest information

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